GB01SLT12-214 1200V 1A SiC Schottky MPS[™] Diode

Silicon Carbide Schottky Diode



VRRM =	1200 V
F (TL ≤ 150°C) =	1 A
Qc =	5 nC

Features

- Low V_F for High Temperature Operation
- Enhanced Surge and Avalanche Robustness
- Superior Figure of Merit Q_C/I_F
- Low Thermal Resistance
- Low Reverse Leakage Current
- Temperature Independent Fast Switching
- Positive Temperature Coefficient of V_{F}
- High dV/dt Ruggedness

Package

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Advantages

- Improved System Efficiency
- High System Reliability
- Optimal Price Performance
- Reduced Cooling Requirements
- Increased System Power Density
- Zero Reverse Recovery Current
- Easy to Parallel without Thermal Runaway
- Enables Extremely Fast Switching

Applications

- High Voltage Sensing
- Solar Inverters
- Electric Vehicles
- High Frequency Converters
- Battery Chargers
- AC/DC Power Supplies
- Anti-Parallel / Free-Wheeling Diode
- LED and HID Lighting

Absolute Maximum Ratings (At T_L = 25°C Unless Otherwise Stated)

Parameter	Symbol	Conditions	Values	Unit	Note
Repetitive Peak Reverse Voltage	V _{RRM}		1200	V	
Continuous Forward Current	l _F	T _L ≤ 150°C	1	Α	
Non-Repetitive Peak Forward Surge Current, Half Sine	I _{F,SM}	T_L = 25°C, t_P = 10 ms	10	А	
Wave		T _L = 150°C, t _P = 10 ms	8		
Repetitive Peak Forward Surge Current, Half Sine Wave	I _{E.RM}	T _L = 25°C, t _P = 10 ms	6	А	
	IF,RM	T∟ = 150°C, tP = 10 ms	5	~	
Non-Repetitive Peak Forward Surge Current	I _{F,MAX}	T _L = 25°C, t _P = 10 μs	50	Α	
i ² t Value	∫i²dt	T∟ = 25°C, t⊵ = 10 ms	0.5	A ² s	
Non-Repetitive Avalanche Energy	E _{AS}	L = 35.9 mH, I _{AS} = 1 A	18	mJ	
Diode Ruggedness	dV/dt	V_R = 0 ~ 960 V	200	V/ns	
Power Dissipation	Ртот	T _L = 25°C	20	W	Fig. 3
Operating and Storage Temperature	T _j , T _{stg}		-55 to 175	°C	

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Electrical Characteristics

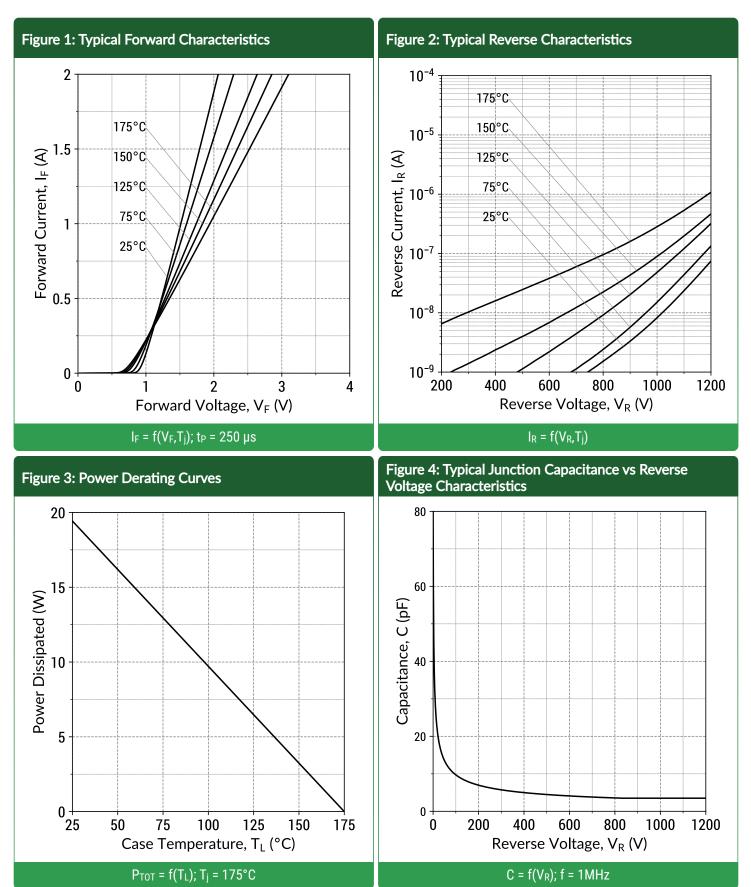
Deveneter	Symbol	Conditions		Values			11	Note
Parameter	Symbol			Min.	Тур.	Max.	Unit	Note
Diode Forward Voltage	V _F	I _F = 1 A, T _j = 25°C			1.5	1.8	V	Fig. 1
	۷F	I _F = 1 A, T _j = 175°C			1.9			
Reverse Current	la la	V _R = 1200 V, T _j = 25°C			1	5	μA	Fig. 2
	I _R	V _R = 1200 V, T _j = 175°C			2			
Total Capacitive Charge	Qc		V _R = 400 V		4		nC	Fig. 5
	QC	I _F ≤ I _{F,MAX}	V _R = 800 V		5	lic	nc	
Switching Time	+-	dI _F /dt = 200 A/µs V _R = 400 V			< 10		20	
	ts		V _R = 800 V		< 10		ns	
Total Capacitance	C	V _R = 1 V, f = 1MHz			61		ъĘ	Fig. 4
	С	V _R = 800 V, f = 1MHz			4		pF	

Thermal/Package Characteristics

Parameter	Symbol Condi	Conditions		Values			Note
Farameter		Conditions	Min.	Тур.	Max.	Unit	Note
Thermal Resistance, Junction - Lead	RthJL			7.72		°C/W	
Weight	WT			0.3		g	

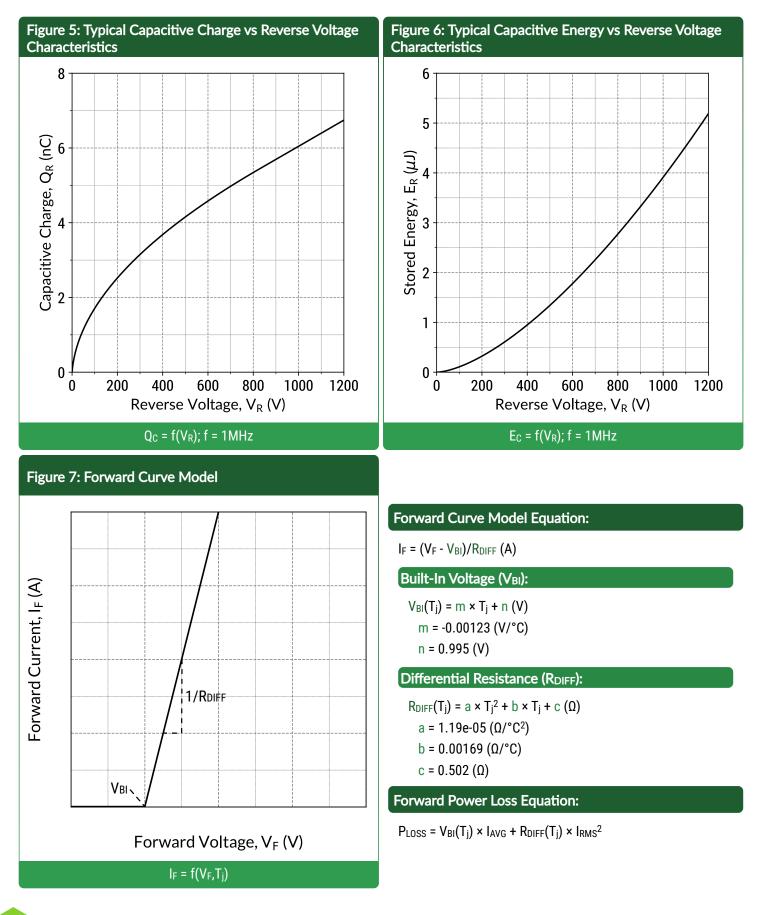
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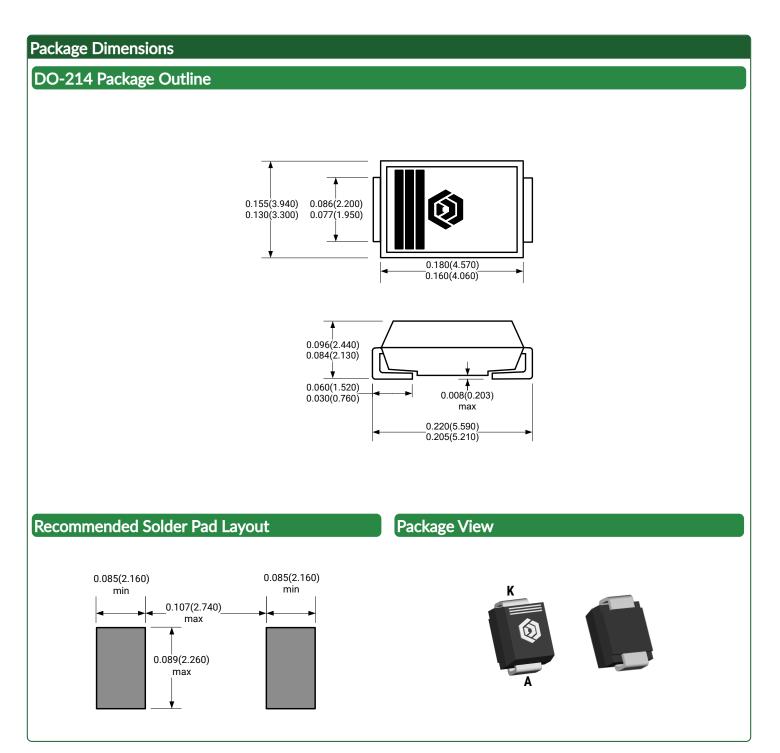
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NOTE

- 1. CONTROLLED DEIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
- 2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS.

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RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS 2), as adopted by EU member states on January 2, 2013 and amended on March 31, 2015 by EU Directive 2015/863. RoHS Declarations for this product can be obtained from your GeneSiC representative.

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REACH substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a GeneSiC representative to insure you get the most up-to-date REACH SVHC Declaration. REACH banned substance information (REACH Article 67) is also available upon request.

This product has not been designed or tested for use in, and is not intended for use in, applications implanted into the human body nor in applications in which failure of the product could lead to death, personal injury or property damage, including but not limited to equipment used in the operation of nuclear facilities, life-support machines, cardiac defibrillators or similar emergency medical equipment, aircraft navigation or communication or control systems, or air traffic control systems.

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